

Features

- Universal specification
- Operating voltage: 2.0V~5.5V
- Low standby current
- Low memory retention current: 0.1μA (Typ.)
- Tone/pulse switchable
- Interface with LCD driver
- 32 digits for redialing
- 32 digits for SA memory dialing
- One-key redialing
- Pause and P→T key for PBX

Patent Number: 86474, 113235(R.O.C.), 5424740(U.S.A.)

- 5×5 keyboard matrix
- Make/Break ratio control
- 3.58MHz crystal or ceramic resonator
- Hand-free control
- Hold-line control
- Pause, P→T can be saved for redialing
- Keystroke function
- Lock function
- CD key
- Memory number: 5 memories

General Description

The HT9246 series tone/pulse dialers are CMOS LSIs for telecommunication systems.

The HT9246 series are offered in various packages from 22-pin DIP to 28-pin DIP. The 22-pin DIP version is suitable for low cost applications, while the 28-pin DIP version supplies versatile functions such as: Hold-line, Hand-free, IDD

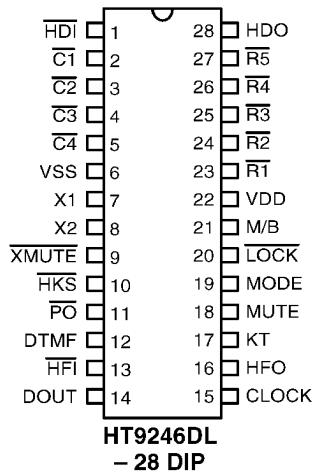
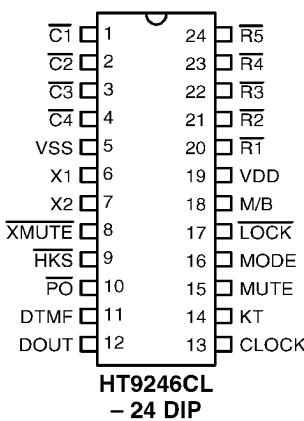
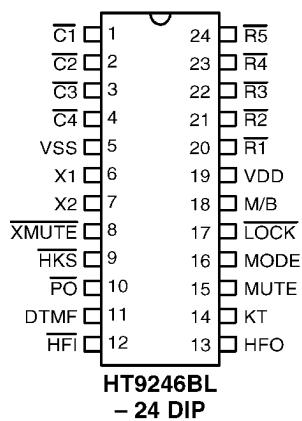
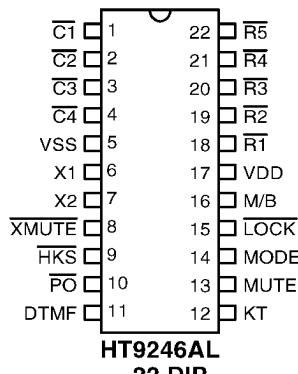
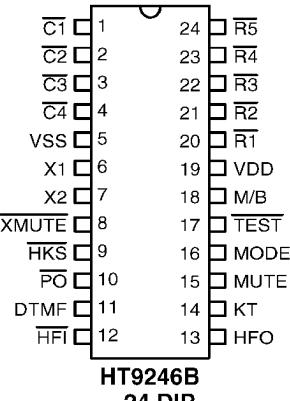
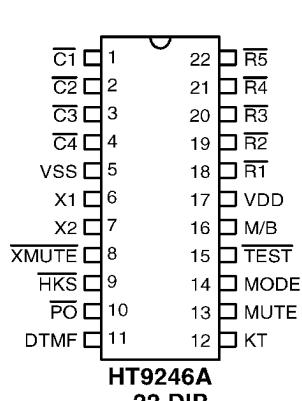
lock and LCD dialing number display interface, all of which are suitable for feature phone applications.

The HT9246 provides SA, Redial and 3 one-touch memory dials for speed dialing in either pulse or tone mode.

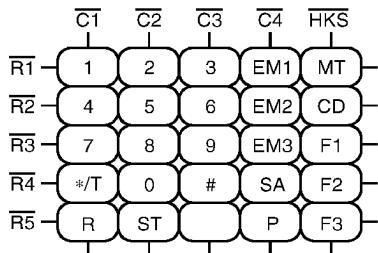
Selection Table

Function Item	Memory Dailing	Hold-Line	Hand-Free	LCD Interface	Flash Function	Flash Time (ms)	Pulse No.	Tone Duration (ms)	Inter-Tone-Pause (ms)	Lock Function	Package
HT9246A	SAR EMI~EMB	—	—	—	Contrd	98,800/600	N	91	91	—	22 DIP
HT9246B	SAR EMI~EMB	—	✓	—	Contrd	98,800/600	N	91	91	—	24 DIP
HT9246AL	SAR EMI~EMB	—	—	—	Contrd	98,800/600	N	91	91	✓	22 DIP
HT9246BL	SAR EMI~EMB	—	✓	—	Contrd	98,800/600	N	91	91	✓	24 DIP
HT9246CL	SAR EMI~EMB	—	—	✓	Contrd	98,800/600	N	91	91	✓	24 DIP
HT9246DL	SAR EMI~EMB	✓	✓	✓	Contrd	98,800/600	N	91	91	✓	28 DIP

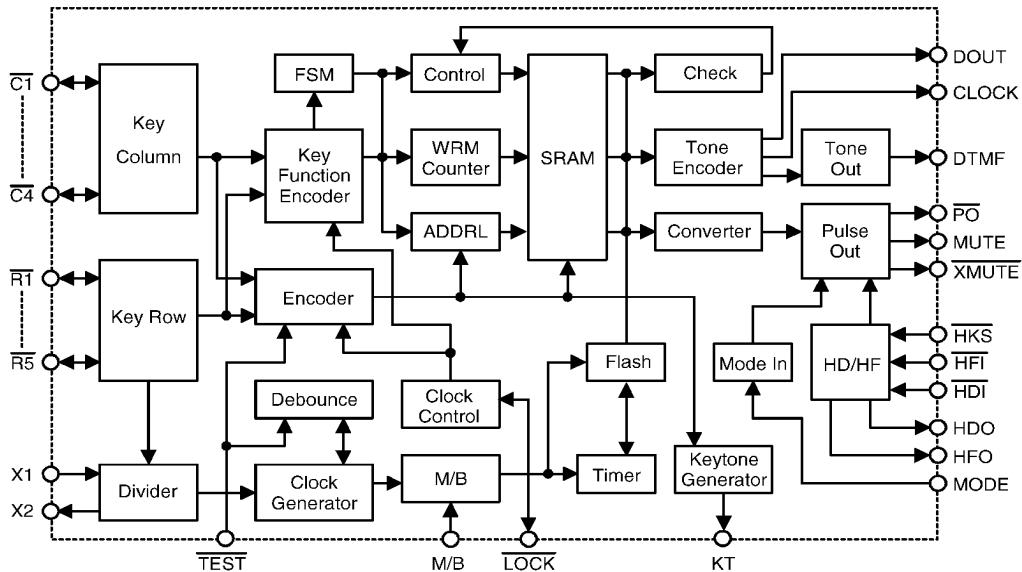
Pin Assignment



Keyboard Information



Block Diagram



Pin Description

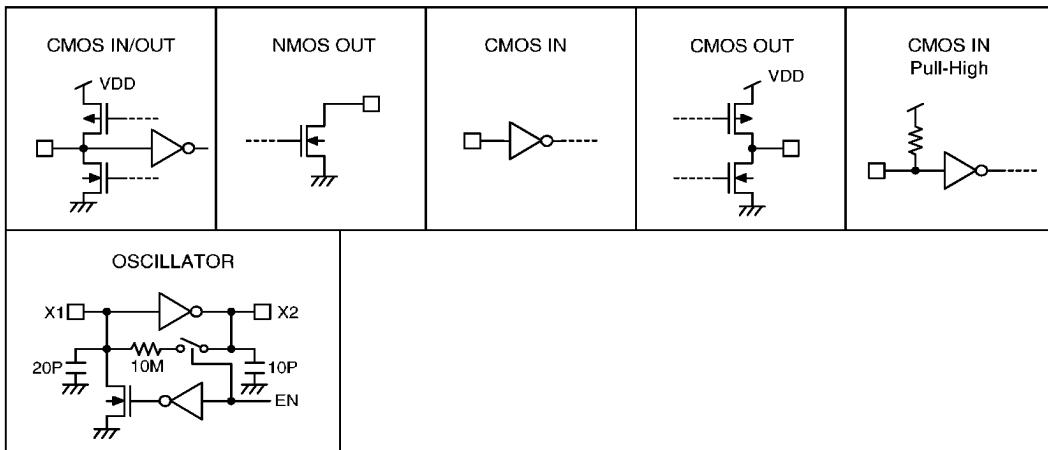
Pin Name	I/O	Internal Connection	Description
<u>C1~C4</u> <u>R1~R5</u>	I/O	CMOS IN/OUT	<p>These pins form a 5x5 keyboard matrix which can perform keyboard input detection. When on-hook (<u>HKS</u>= high) all the pins are set high. While off-hook the column group (<u>C1~C4</u>) remains low and the row group (<u>R1~R5</u>) is set high for key input detection.</p> <p>An inexpensive single contact 5x5 keyboard can be used as an input device. Pressing a key connects a single column to a single row, and actuates the system oscillator to result in a dialing signal output. If more than two keys are pressed at the same time, no response occurs. The key-in debounce time is 20ms. Refer to the keyboard information for keyboard arrangement and to the functional description for dialing specification selection.</p>
X1	I	OSCILLATOR	<p>The system oscillator consists of an inverter, a bias resistor and the necessary load capacitor on chip. Connecting a standard 3.579545MHz crystal or ceramic resonator to the X1 and X2 terminals can implement the oscillator function. The oscillator is turned off in the standby mode, and is actuated whenever a keyboard entry is detected.</p>
X2	O		

Pin Name	I/O	Internal Connection	Description
<u>XMUTE</u>	O	CMOS OUT	<u>XMUTE</u> is a CMOS output structure pulled to VSS during <u>dialing</u> signal transmission. Otherwise, it remains "high". <u>XMUTE</u> is used to mute the speech circuit when transmitting the dial signal.
<u>HKS</u>	I	CMOS IN Pull-High	This pin is used to monitor the status of the hook-switch and its combination with <u>HFI</u> can control the <u>PO</u> pin output to make or break the line. <u>HKS</u> =VDD: On-hook state (<u>PO</u> =low). Except <u>HFI/HDI</u> (hand-free/hold-line control input), other functions are all disabled. <u>HKS</u> =VSS: Off-hook state (<u>PO</u> =high). The chip is in the standby mode and ready to receive the key input.
<u>PO</u>	O	CMOS OUT	This pin is a CMOS output structure which by receiving the <u>HKS</u> and <u>HFO</u> signals, control the dialer to connect or disconnect the telephone line. <u>PO</u> outputs a low to break the line when <u>HKS</u> is high (on-hook) and <u>HFO</u> is low (hand-free inactive). <u>PO</u> outputs a high to make the line when <u>HKS</u> is low (off-hook) or <u>HFO</u> is high or <u>HDO</u> is high. During the off-hook state, this pin also outputs the dialing pulse train in pulse mode dialing. While in the tone mode, this pin is always high.
<u>MODE</u>	I	CMOS IN	This is an input pin, used for dialing mode selection, either Tone mode or Pulse mode, 10pps <u>MODE</u> =VDD: Pulse mode, 10pps <u>MODE</u> =VSS: Tone mode During pulse mode dialing, switching this pin to the tone mode changes the subsequent digit entry to tone mode. When the chips are in tone mode, switching to pulse mode will also be recognized.
<u>MUTE</u>	O	CMOS OUT	<u>MUTE</u> is a CMOS output structure pulled to VDD during Tone (DTMF) output transmission. Otherwise, it continuously remains "low".
<u>M/B</u>	I	CMOS IN	This is a Make/Break ratio selection pin in pulse mode. Otherwise, it has no function. <u>M/B</u> =VDD: Make/Break ratio is 40/60 <u>M/B</u> =VSS: Make/Break ratio is 33/66
<u>DTMF</u>	O	CMOS OUT	This pin is active only when the chip transmits tone dialing signals. Otherwise, it always outputs a low. The pin outputs tone signals to drive the external transmitter amplifier circuit. The load resistor should not be less than $5\text{k}\Omega$.

Pin Name	I/O	Internal Connection	Description
<u>HDI</u>	I	CMOS IN Pull-High	This pin is a schmitt trigger input structure. Active low. Applying a negative going pulse to this pin can toggle the HDO output once. An external RC network is recommended for input debouncing. The pull-high resistance is 200kΩ typ.
HDO	O	CMOS OUT	The HDO is a CMOS output structure. Its output is toggle-controlled by a negative transition on <u>HDI</u> . When HDO is toggled high, PO keeps high to hold the line. The hold function can be released by setting HFO high or by an on-off hook operation or by another <u>HDI</u> input. The HDO pin can directly drive the HT3810 series melody generators to produce a hold-line background melody. Refer to the functional description for the hold-line function.
<u>HFI</u>	I	CMOS IN Pull-High	This pin is a schmitt trigger input structure. Active low. Applying a negative going pulse to <u>HFI</u> can toggle HFO once and hence control the hand-free function. The pull-high resistance of <u>HFI</u> is 200kΩ typ. An external RC network is recommended for input debouncing.
HFO	O	CMOS OUT	The HFO is a CMOS output structure. Its output is toggle-controlled by a negative transition on the HFI pin. When HFO is high, the hand-free function is enabled and PO outputs a high to connect the line. The hand-free function can be released by an on-off-hook operation or by another <u>HFI</u> input or by setting HDO high. Refer to the functional description for the hand-free functional operation.
DOUT	O	NMOS OUT	NMOS open drain output pin. It outputs the BCD code of the dialing digits to the LCD driver chip (HT16XX series) or µC for dialing number display. Refer to the functional description for the detailed timing.
CLOCK	O	NMOS OUT	NMOS open drain output. When dialing, it outputs a series of pulse trains for DOUT data synchronization. DOUT data is valid at the falling edge of the clock.
KT	O	CMOS OUT	Keystroke output pin. Outputs a 1.2kHz tone carrier when any key is pressed in the pulse mode or when the function keys are pressed in the Tone (DTMF) mode.
<u>TEST</u>	I	CMOS IN	For IC test only. <u>TEST</u> =VDD for normal operation

Pin Name	I/O	Internal Connection	Description
LOCK	I/O	CMOS IN/OUT	This is a three-state input-output pin, used for controlling long distance call function with a lock-switch. LOCK=VDD: Normal dialing LOCK=OPEN: "0, 9" is inhibited for use as the first key input LOCK=VSS: "0" is inhibited for use as the first key input
VDD	I	—	Positive power supply, 2.0V~5.5V for normal operation
VSS	I	—	Negative power supply

Approximate internal connection circuits



Absolute Maximum Ratings*

Supply Voltage	-0.3V to 6V	Storage Temperature	-50°C to 125°C
Input Voltage	VSS-0.3 to VDD+0.3V	Operating Temperature	-20°C to 75°C

*Note: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation of this device at these or any other conditions above those indicated in the operational sections of this specification is not implied and exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Electrical Characteristics

(FOSC=3.5795MHz, Ta=25°C)

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
		V_{DD}	Conditions				
V _{DD}	Operating Voltage	—	—	2	—	5.5	V
I _{DD}	Operating Current	2.5V	Pulse	—	0.2	1	mA
			Tone	Off-hook Keypad entry No load	—	0.6	2
I _{STB}	Standby Current	1V	On-hook, no load No entry	—	—	1	μA
V _R	Memory Retention Voltage	—	—	1	—	5.5	V
I _R	Memory Retention Current	1V	On-hook	—	0.1	0.2	μA
V _{IL}	Input Low Voltage	—	—	V _{SS}	—	0.2V _{DD}	V
V _{IH}	Input High Voltage	—	—	0.8V _{DD}	—	V _{DD}	V
I _{OHXM}	Mute Pin Source Current (XMUTE, MUTE)	2.5V	V _{OH} =2V	-1	—	—	mA
I _{OLXM}	Mute Pin Sink Current (XMUTE, MUTE)	2.5V	V _{OL} =0.5V	1	—	—	mA
I _{HKS}	HKS Pin Input Current	2.5V	V _{HKS} =2.5V	—	—	0.1	μA
R _{HFI}	HFI Pull-High Resistance	2.5V	V _{HFI} =0V	—	200	—	kΩ
R _{HDI}	HDI Pull-High Resistance	2.5V	V _{HDI} =0V	—	200	—	kΩ
R _{HKS}	HKS Pull-High Resistance	2.5V	V _{HKS} =0V	—	1	—	MΩ
T _{F1}	Flash Time for F1 key	—	—	—	98	—	ms
T _{F2}	Flash Time for F2 key	—	—	—	300	—	ms
T _{F3}	Flash Time for F3 key	—	—	—	600	—	ms
I _{OH1}	Keypad Pin Source Current	2.5V	V _{OH} =0V	-4	—	-40	μA
I _{OL1}	Keypad Pin Sink Current	2.5V	V _{OL} =2.5V	200	400	—	μA
I _{OH2}	HFO Pin Source Current	2.5V	V _{OH} =2V	-1	—	—	mA
I _{OL2}	HFO Pin Sink Current	2.5V	V _{OL} =0.5V	1	—	—	mA
I _{OH3}	HDO Pin Source Current	2.5V	V _{OH} =2V	-1	—	—	mA
I _{OL3}	HDO Pin Sink Current	2.5V	V _{OL} =0.5V	1	—	—	mA
T _{FP}	Pause Time After Flash	—	Control key	—	0.2	—	s
T _{RP}	Pause Time for One-key Redialing	—	One-key redialing	—	0.6	—	s
T _{DB}	Key-in Debounce Time	—	—	—	20	—	ms

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
		V_{DD}	Conditions				
T _{KTD}	Keytone Delay	—	—	—	20	—	ms
T _{KTR}	Keytone Release	—	—	—	20	—	ms
T _{BRK}	Break Time for One-key Redialing	—	One-key redialing	—	2.2	—	s
FOSC	System Frequency	—	Crystal=3.5795MHz	3.5759	3.5795	3.5831	MHz

Pulse Mode Electrical Characteristics

(FOSC=3.5795MHz, Ta=25°C)

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
		V_{DD}	Conditions				
I _{POH}	PO Output Source Current	2.5V	V _{OH} =2V	—0.2	—	—	mA
I _{POL}	PO Output Sink Current	2.5V	V _{OL} =0.5V	0.2	0.6	—	mA
PR	Pulse Rate	—	MODE pin is connected to VDD	—	10	—	pps
M/B	Make/Break Ratio	—	M/B=VSS	—	33:66	—	%
			M/B=VDD	—	40:60	—	
T _{PD}	Pre-digit-pause Time	—	M/B ratio=40:60	—	40	—	ms
			M/B ratio=33:66	—	33	—	
T _{IDP}	Inter-digit-pause Time	—	Pulse rate=10pps	—	800	—	ms
T _M	Pulse Make Duration	—	M/B ratio=33:66	—	33	—	ms
			M/B ratio=40:60	—	40	—	
T _B	Pulse Break Duration	—	M/B ratio=33:66	—	66	—	ms
			M/B ratio=40:60	—	60	—	

Tone Mode Electrical Characteristics

(FOSC=3.5795MHz, Ta=25°C)

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
		V_{DD}	Conditions				
V _{TDC}	DTMF Output DC Level	—	—	0.45V _{DD}	—	0.7V _{DD}	V
I _{TOL}	DTMF Sink Current	2.5V	V _{DTMF} =0.5V	0.1	—	—	mA
V _{TAC}	DTMF Output AC Level	—	Row group, R _L =5kΩ	0.12	0.155	0.18	Vrms
R _L	DTMF Output Load	2.5V	THD≤-23dB	5	—	—	kΩ
ACR	Column Pre-emphasis	2.5V	Row group=0dB	1	2	3	dB
THD	Tone Signal Distortion	2.5V	R _L =5kΩ	—	-30	-23	dB
T _{TMIN}	Minimum Tone Duration	—	Auto-redial	—	91	—	ms
T _{ITPM}	Minimum Inter-tone Pause	—	Auto-redial	—	91	—	ms

$$\text{THD (Distortion) (dB)} = 20 \log (\sqrt{V1^2 + V2^2 + \dots + Vn^2} / \sqrt{Vi^2 + Vh^2})$$

Vi, Vh: Row group and column group signals

V1, V2, ... Vn: Harmonic signals (BW=300Hz~3500Hz)

Functional Description
Keyboard matrix

C₁~C₄ and R₁~R₅ form a keyboard matrix. Together with a standard 5×5 keyboard, the keyboard matrix is used for dialing entries. The keyboard arrangement for the HT9246 series is shown in the **Keyboard Information**.

Tone frequency

Tone Name	Output Frequency (Hz)		% Error
	Specified	Actual	
R ₁	697	699	+0.29%
R ₂	770	766	-0.52%
R ₃	852	847	-0.59%
R ₄	941	948	+0.74%
C ₁	1209	1215	+0.50%
C ₂	1336	1332	-0.30%
C ₃	1477	1472	-0.34%

Note: % Error does not contain the crystal frequency drift

M/B ratio selection table

M/B Pin	M/B Ratio (%)
VDD	40:60
VSS	33.3:66.6

Flash function/time (duration) selection table

Key-In	Flash Function	Flash Time (T _F)
F1	Control	98ms
F2	Control	300ms
F3	Control	600ms

Pause and P→T duration table

T _P (sec)	T _{P→T} (sec)
3.1	3.1

Pulse number table

Keypad	Output Pulse Number	
	Normal N	
1		1
2		2
3		3
4		4
5		5
6		6
7		7
8		8
9		9
0		10
*/T		P→T
#		Ignored

Tone duration and pause in redial function

Parameter	Symbol	Typ.	Unit
Minimum Tone Duration	T _{TMIN}	91	ms
Minimum Inter-tone Pause	T _{ITPM}	91	ms
Cycle Time	T _C	182	ms

Hand-free function operation

- Hand-free function execution
When HFO is low, a falling edge triggers the \overline{HFI} , enabling the Hand-free function (HFO becomes high).
- Reset Hand-free function
When HFO is high, the Hand-free function is enabled and can be reset by:
 - ♦ Off-hook
 - ♦ Applying a falling edge to \overline{HFI}
 - ♦ Changing the HDO pin from low to high
- Hand-free function table

Current State			Input			Next State	
HKS	HFO	HDO	HDI	\overline{HFI}	HKS	HFO	HDO
H	L	X	H	H	An	L	An
H	L	X	H	$\overline{\downarrow}$	An	H	L
H	H	X	H	$\overline{\downarrow}$	An	L	An
H	X	L	H	H	L	L	L
L	L	X	H	H	An	L	An
L	L	X	H	$\overline{\downarrow}$	An	H	L
L	H	L	H	$\overline{\downarrow}$	An	L	An
L	X	X	H	H	H	An	An
X	X	L	$\overline{\downarrow}$	H	An	L	H

H: Logic HIGH X: Don't care

L: Logic LOW An: Unchanged

 : Rising edge

 : Falling edge

Hold-line function operation

- Hold-line function execution

When HDO is low, a falling edge triggers HDI, enabling the Hold-line function (HDO becomes high). The XMUTE remains low when HDO is high.

- Reset Hold-line function

When HDO is high, the Hold-line function is enabled and can be reset by:

- Off-hook
- Applying a falling edge to HDI
- Changing the HFO pin from low to high

- Hold-line function table

Current State			Input			Next State		
HKS	HDO	HFO	HFI	HDI	HKS	HDO	HFO	
H	L	X	H	H	An	L	An	
H	L	X	H	↓	An	H	L	
H	H	L	H	↓	An	L	An	
H	X	X	H	H	L	L	L	
L	L	X	H	H	An	L	An	
L	L	X	H	↓	An	H	L	
L	H	L	H	↓	An	L	An	
L	X	X	H	H	H	An	An	
X	X	L	↓	H	An	L	H	

H: Logic HIGH

X: Don't care

L: Logic LOW

An: Unchanged

↑ : Rising edge

↓ : Falling edge

DOUT BCD code

When dialing, the corresponding 4-bit BCD codes are serially presented on DOUT from MSB to LSB. The data of DOUT is valid at the falling edge of the CLOCK pin.

The following table lists the BCD codes corresponding to the keyboard input.

Key-In	BCD Code	Key-In	BCD Code
1	0001	8	1000
2	0010	9	1001
3	0011	0	1010
4	0100	*/T	1101
5	0101	#	1100
6	0110	F	1011
7	0111	P	1110

Key definition

- 0,1,2,3,4,5,6,7,8,9 keys

These are dialing number input keys for both the pulse mode and the tone mode operations.

- */T

This key executes the P→T function and waits a T_P duration in the pulse mode. On the other hand, the */T key executes the * function in the tone mode.

- #

This is a dialing signal key for the tone mode only, no response in the pulse mode.

- SA

Pressing this key can save the preceding dialing telephone numbers. The saved number is redialed if it is pressed again. SA will also redial the saved number if it is the first key pressed at the off-hook state. During the dialing signal transmission, the SA key is inhibited.

- P

Pause key. The execution of this key pauses the output for the T_P duration. T_P is 3.1 secs.

- F1~F3

The flash keys are control keys. Pressing the F1~F3 keys will force the \overline{PO} pin to be “low” for the T_F duration and is then followed by T_{FP} (sec).

Key-In	Flash Time
F1	98ms
F2	300ms
F3	600ms

- R

Redial key. Executes redialing as well as one-key redial function.

- MT

The MUTE and \overline{XMUTE} pin outputs are toggled when the MT key is pressed.

- ST

Store key. The execution of this key actuates the store memory function with (or without) dialing output. During the dialing signal transmission, the ST key is inhibited.

- EM1~EM3

One-touch memory dialing key. For speed-calling convenience, they provide memory dialing in either pulse or tone mode.

- CD

Call disconnect key. When pressed, the chip will reset to its initial state.

Keyboard operation

The following operations are described under an on-off-hook or on-hook condition with the hand-free active condition.

- Normal dialing

 - Pulse mode

 - (a) without */T

Keyboard input: **[D1] [D2] ... [Dn]**

Dialing output: D1 D2 ... Dn

RM: D1 D2 ... Dn

SAM: Unchanged

 - (b) with */T

Keyboard input: **[D1] [D2] ... [Dn] */T [Dn+1] ...**

[Dm]

Dialing output: **D1 D2 ... Dn** $\underbrace{\text{TP} \rightarrow \text{T}}$ **Dn+1 ... Dm**

Pulse
RM: D1 D2 ... Dn */T Dn+1 ... Dm

Tone
SAM: Unchanged

 - Tone mode

 - (a) without */T

Keyboard input: **[D1] [D2] ... [Dn]**

Dialing output: D1 D2 ... Dn

RM: D1 D2 ... Dn

SAM: Unchanged

 - (b) with */T

Keyboard input: **[D1] [D2] ... [Dn] */T [Dn+1] ...**

[Dm]

Dialing output: D1 D2 ... Dn * Dn+1 ... Dm

RM: D1 D2 ... Dn * Dn+1 ... Dm

SAM: Unchanged

Note: The maximum capacity of the RM memory is 32 digits. When more than 32 digits are entered, the signal is transmitted but the redial function is inhibited

- Redial

 - Pulse mode

 - (a) without */T

RM content: D1 D2 ... Dn

Keyboard input: **[R]**

Dialing output: D1 D2 ... Dn

RM: Unchanged

SAM: Unchanged

 - (b) with */T

RM content: D1 D2 ... Dn */T Dn+1 ... Dm

Keyboard input: **[R]**

Dialing output: **D1 D2 ... Dn** $\underbrace{\text{TP} \rightarrow \text{T}}$ **Dn+1 ... Dm**

Pulse

Tone

RM: Unchanged

SAM: Unchanged

 - Tone mode

 - (a) without */T

RM content: D1 D2 ... Dn

Keyboard input: **[R]**

Dialing output: D1 D2 ... Dn

RM: Unchanged

SAM: Unchanged

 - (b) with */T

RM content: D1 D2 ... Dn */T Dn+1 ... Dm

Keyboard input: **[R]**

Dialing output: D1 D2 ... Dn * Dn+1 ... Dm

RM: Unchanged

SAM: Unchanged

- One-key redial

 - Pulse mode

 - (a) without */T

Keyboard input: **D1 D2 ... Dn R**

Dialing output: D1 D2 ... Dn TBRK TRP
D1 D2 ... Dn

RM: D1 D2 ... Dn

SAM: Unchanged

 - (b) with */T

Keyboard input: **D1 D2 ... Dn */T Dn+1 ... Dm R**

Dialing output: **D1 D2 ... Dn**
 Pulse Tone
 TBRK TRP **D1 D2 ... Dn** TP→T
 Pulse
Dn+1 ... Dm
 Tone

RM: D1 D2 ... Dn */T Dn+1 ... Dm

SAM: Unchanged

 - Tone mode

 - (a) without */T

Keyboard input: **D1 D2 ... Dn R**

Dialing output: D1 D2 ... Dn TBRK TRP D1 D2
... Dn

RM: D1 D2 ... Dn

SAM: Unchanged

 - (b) with */T

Keyboard input: **D1 D2 ... Dn */T Dn+1 ... Dm R**

Dialing output: D1 D2 ... Dn * Dn+1 ... Dm
TBRK TRP D1 D2 ... Dn * Dn+1
... Dm

RM: D1 D2 ... Dn * Dn+1 ... Dm

SAM: Unchanged

Note: If the dialing number exceeds 32 digits, redialing is inhibited and $\overline{PO}=VDD$

- SA copy

 - Pulse mode

 - (a) without */T

Keyboard input: **D1 D2 ... Dn R**

Dialing output: D1 D2 ... Dn

RM: D1 D2 ... Dn

SAM: D1 D2 ... Dn

 - (b) with */T

Keyboard input: **D1 D2 ... Dn */T Dn+1 ... Dm SA**

Dialing output: **D1 D2 ... Dn**
 Pulse Tone
 RM: D1 D2 ... Dn */T Dn+1 ... Dm

SAM: D1 D2 ... Dn */T Dn+1 ... Dm

 - Tone mode

 - (a) without */T

Keyboard input: **D1 D2 ... Dn R**

Dialing output: D1 D2 ... Dn

RM: D1 D2 ... Dn

SAM: D1 D2 ... Dn

 - (b) with */T

Keyboard input: **D1 D2 ... Dn */T Dn+1 ... Dm SA**

Dialing output: D1 D2 ... Dn * Dn+1 ... Dm
RM: D1 D2 ... Dn * Dn+1 ... Dm
SAM: D1 D2 ... Dn * Dn+1 ... Dm

Note: The maximum capacity of the RM memory is 32 digits. When more than 32 digits plus the "SA" key are entered, the SAVE function will not be executed, and all the existing data in the save memory will not be changed.

- SA dialing

 - Pulse mode

 - (a) without */T

SAM content: D1 D2 ... Dn

Keyboard input: **[SA]**

Dialing output: D1 D2 ... Dn

RM: Unchanged

SAM: Unchanged

 - (b) with */T

SAM content: D1 D2 ... Dn */T Dn+1 ... Dm

Keyboard input: **[SA]**

Dialing output: D1 D2 ... Dn _{Pulse} $\xrightarrow{TP \rightarrow T}$ Dn+1 ... Dm _{Tone}

RM: Unchanged

SAM: Unchanged

 - Tone mode

 - (a) without */T

SAM content: D1 D2 ... Dn

Keyboard input: **[SA]**

Dialing output: D1 D2 ... Dn

RM: Unchanged

SAM: Unchanged

 - (b) with */T

SAM content: D1 D2 ... Dn * Dn+1 ... Dm

Keyboard input: **[SA]**

Dialing output: D1 D2 ... Dn * Dn+1 ... Dm

RM: Unchanged

SAM: Unchanged

- Memory store

 - (a) without dialing output

Keyboard input: **[ST] [D1] [D2] ... [Dn] [ST] [EMa]**

Dialing output:

EMa: D1 D2 ... Dn

RM: D1 D2 ... Dn

SAM: Unchanged

 - (b) with dialing output

Keyboard input: **[D1] [D2] ... [Dn] [ST] [ST] [EMa]**

Dialing output: D1 D2 ... Dn

EMa: D1 D2 ... Dn

RM: D1 D2 ... Dn

SAM: Unchanged

Note: If the dialing number exceeds 32 digits, the memory store is inhibited.

However, if the dialing number is more than 32 digits, the memory will store a max. of 16 digits

EMa=EM1~EM3

- Memory dialing

EMa content: D1 D2 ... Dn

Keyboard input: **[EMa]**

Dialing output: D1 D2 ... Dn

EMa: Unchanged

RM: D1 D2 ... Dn

SAM: Unchanged

Note: EMa=EM1~EM3.

- Chain dialing

EM1 content: D1 D2 ... Dn

EM2 content: Dn+1 ... Dm

Keyboard input: **D1 D2 D3 EM1 EM2**

Dialing output: D1 D2 D3 D1 D2 ... Dn Dn+1 ... Dm

EM1/EM2: Unchanged

RM: D1 D2 D3 D1 D2 ... Dn Dn+1 ... Dm

SAM: Unchanged

Note: The maximum capacity of the RM memory is 32 digits. When the dialing number exceeds 32 digits, redialing is inhibited and $\overline{PO}=VDD$

- Flash

Keyboard input: **D1 D2 ... Dn F Dn+1 ... Dm**

Dialing output: D1 D2 ... Dn T_F T_{FP} Dn+1 ... Dm

RM: Dn+1 ... Dm

SAM: Unchanged

Note: T_F: break a flash time

F: any one of the F1~F3

- Pause

Keyboard input: **D1 D2 ... Dn P Dn+1 ... Dm**

Dialing output: D1 D2 ... Dn T_P Dn+1 ... Dm

RM: D1 D2 ... Dn P Dn+1 ... Dm

SAM: Unchanged

- Note

RM: Redial memory

SAM: Save dialing memory

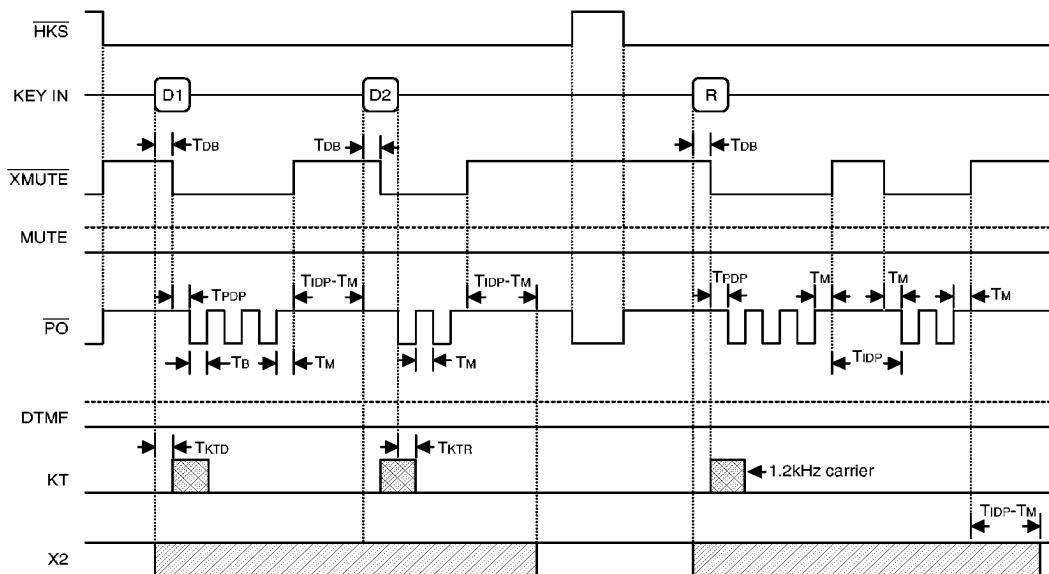
D1 D2 ... Dn: 0~9

Dn+1 ... Dm: 0~9, *, #

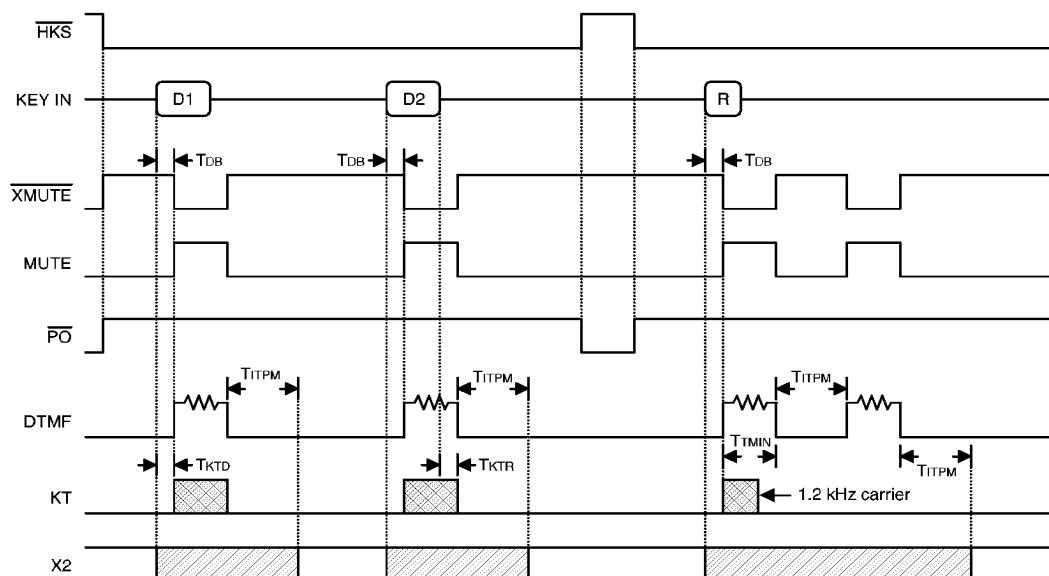
Timing Diagrams

Normal dialing

- Pulse mode

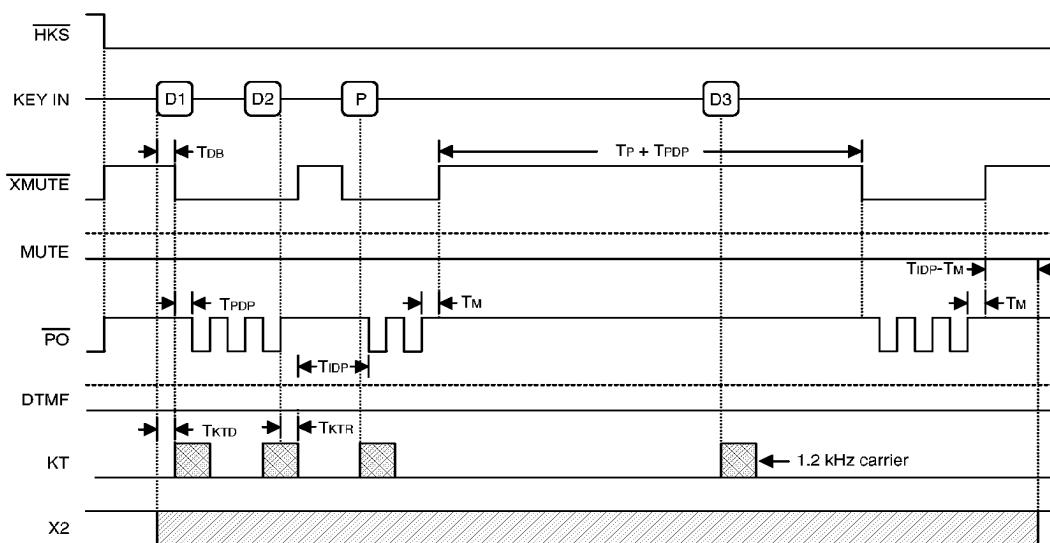


- Tone mode

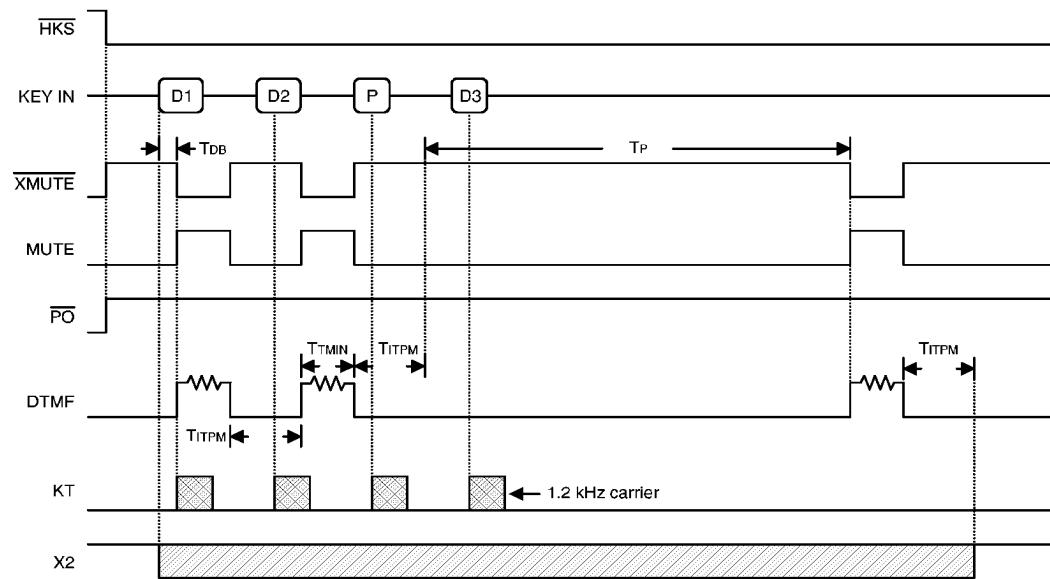


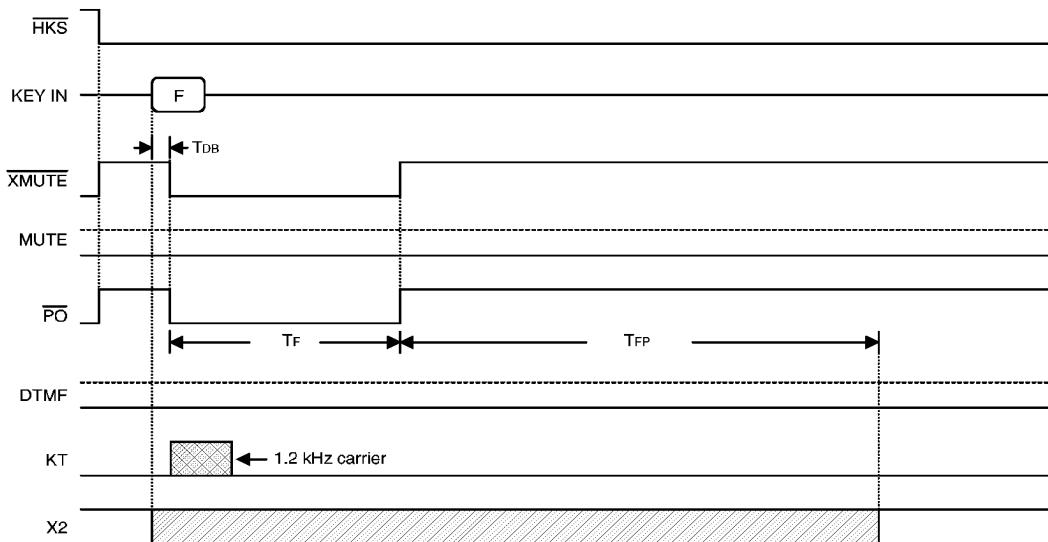
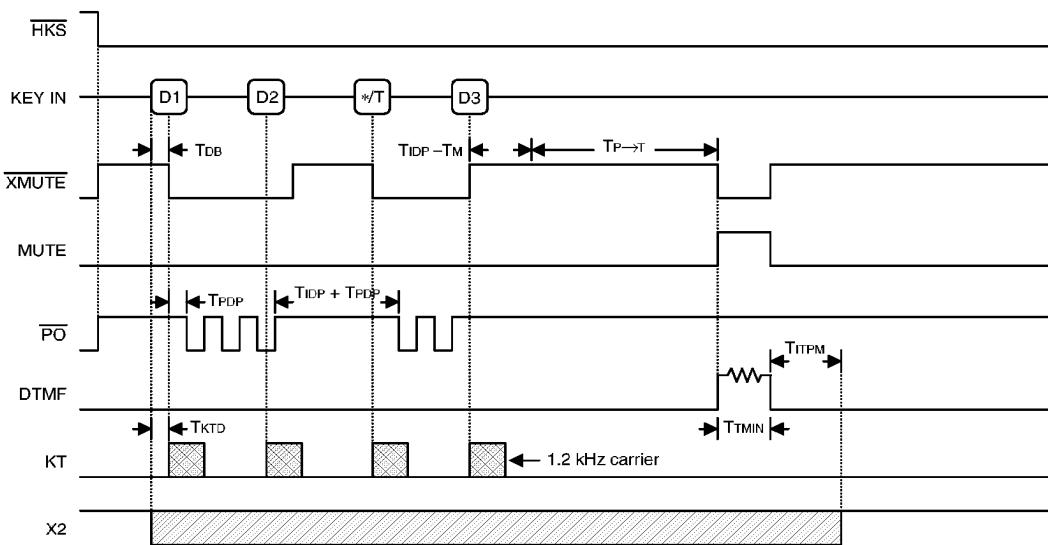
Dialing with pause key

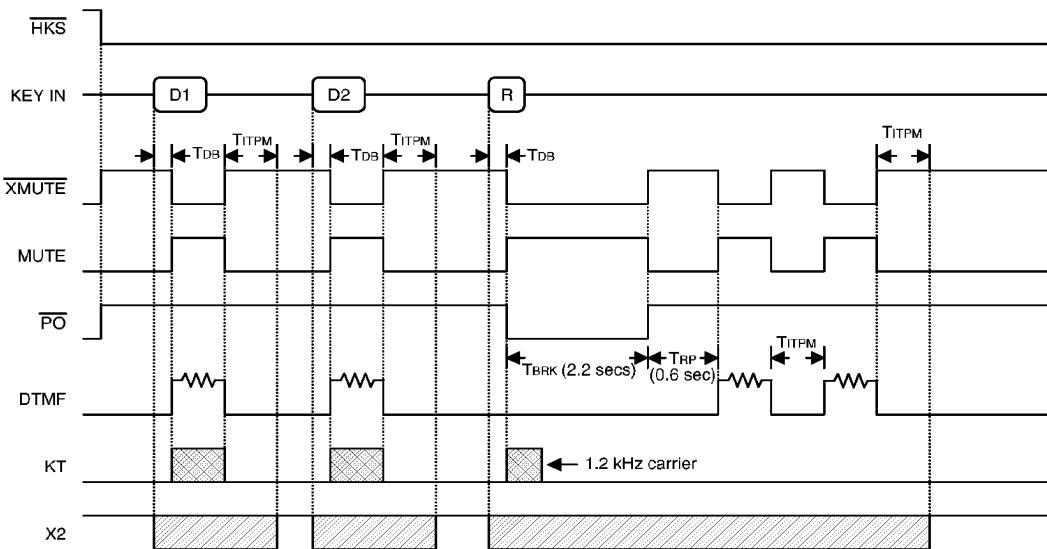
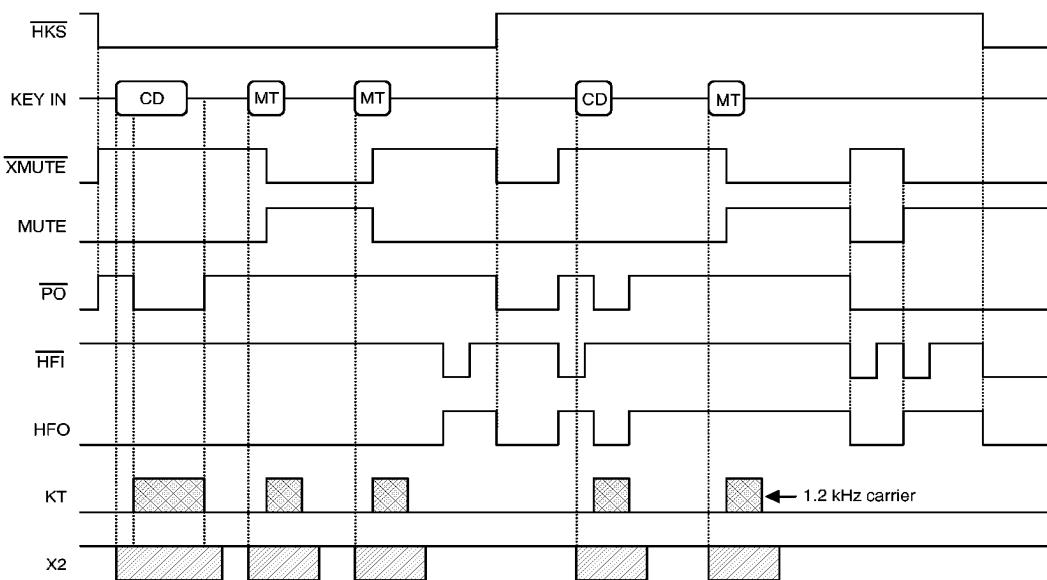
- Pulse mode

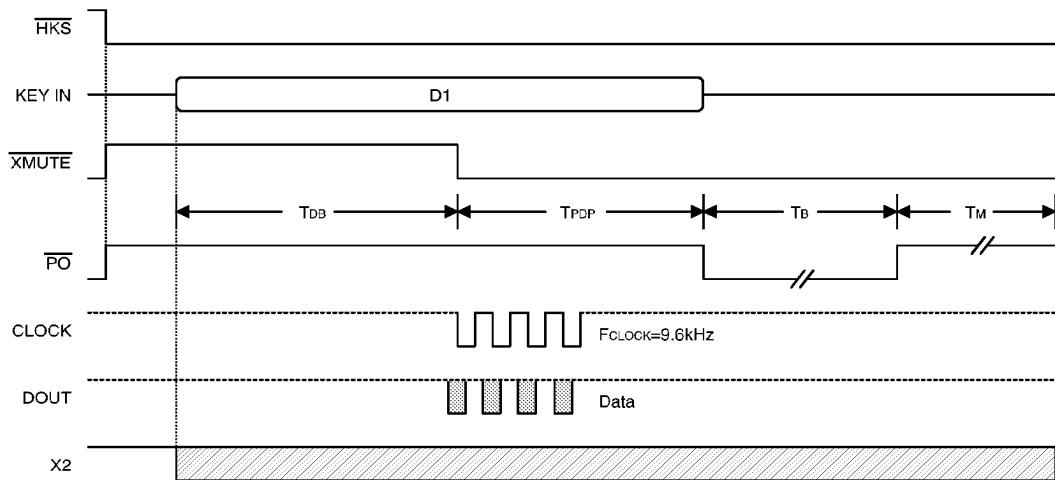


- Tone mode



Flash key operation

Pulse→Tone operation


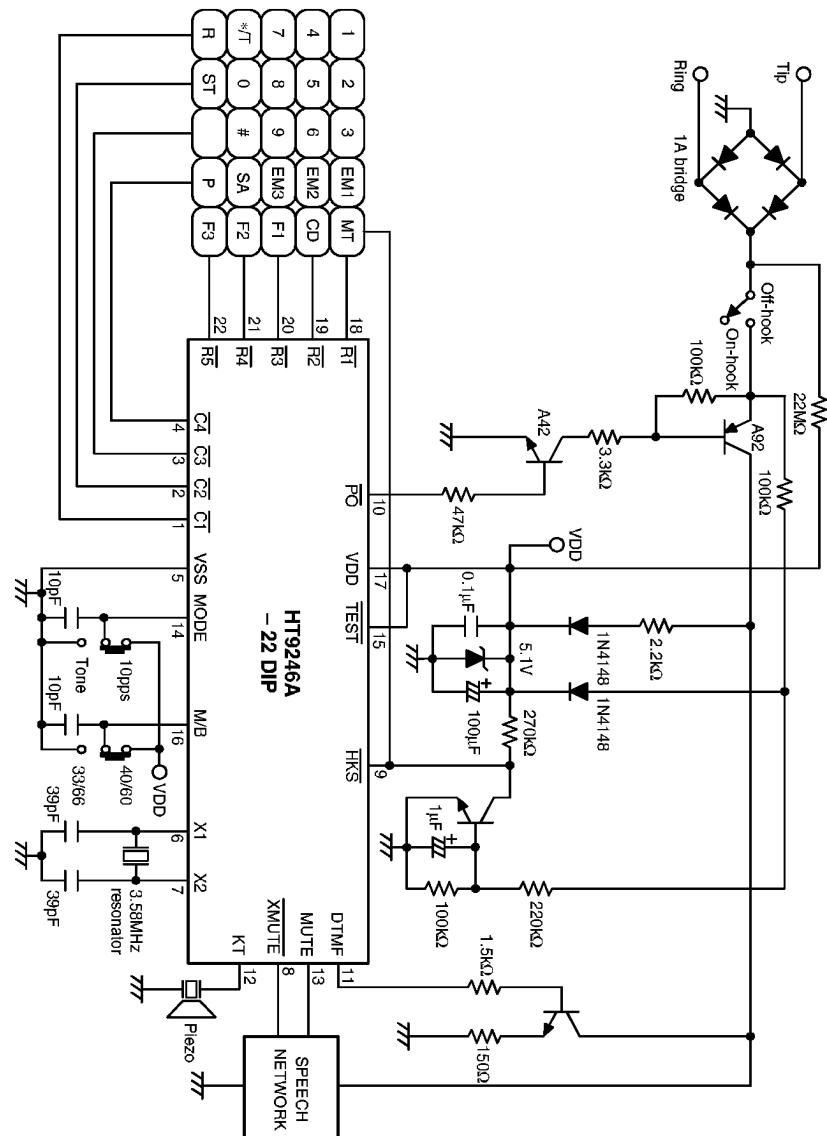
One key redial operation

Call disconnect (CD) & MUTE (MT) operation


CLOCK & DOUT operation


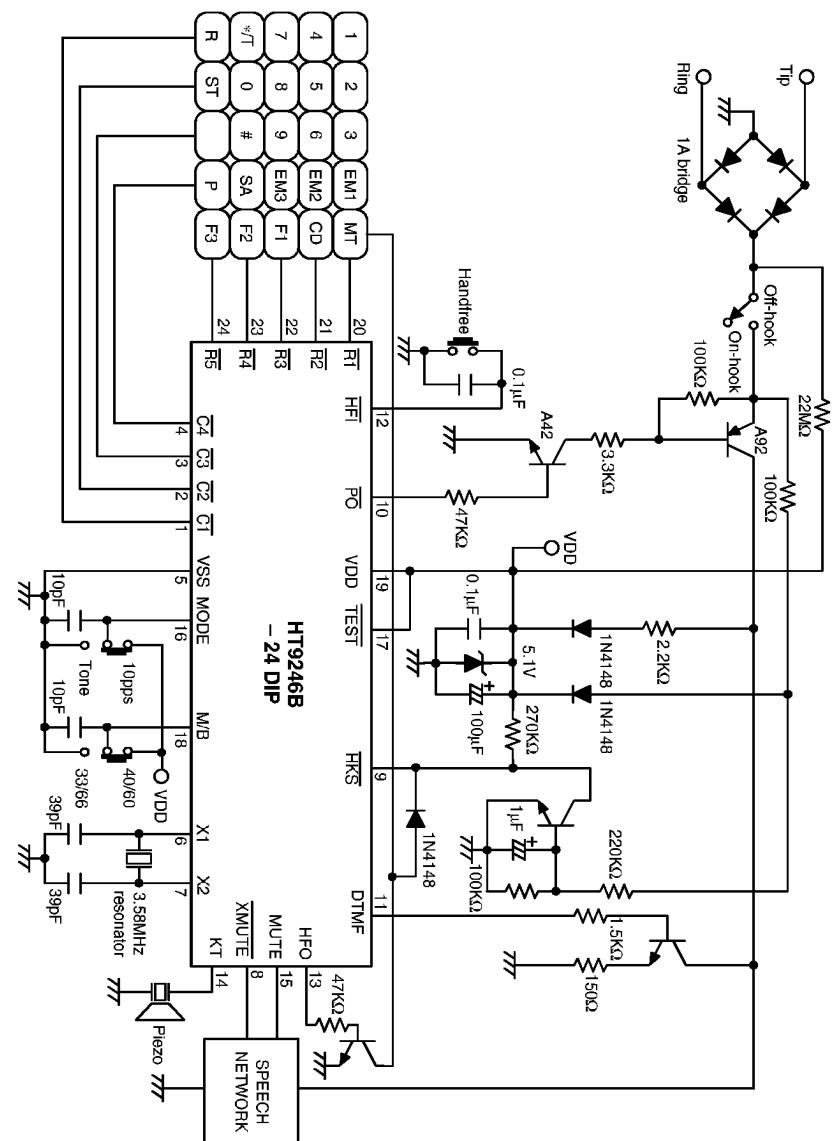
Note: D1=D3=3
D2=2

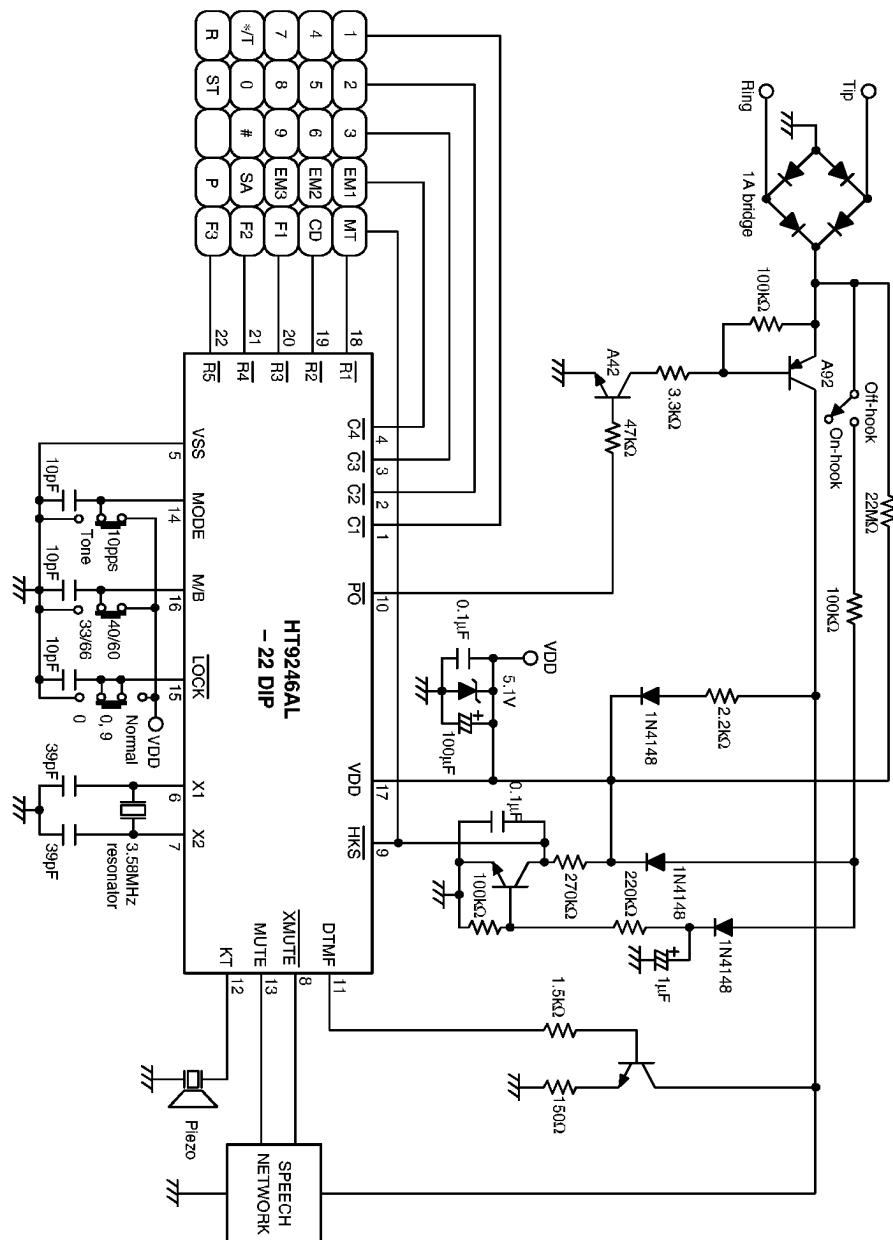
Application Circuits

Application circuit 1



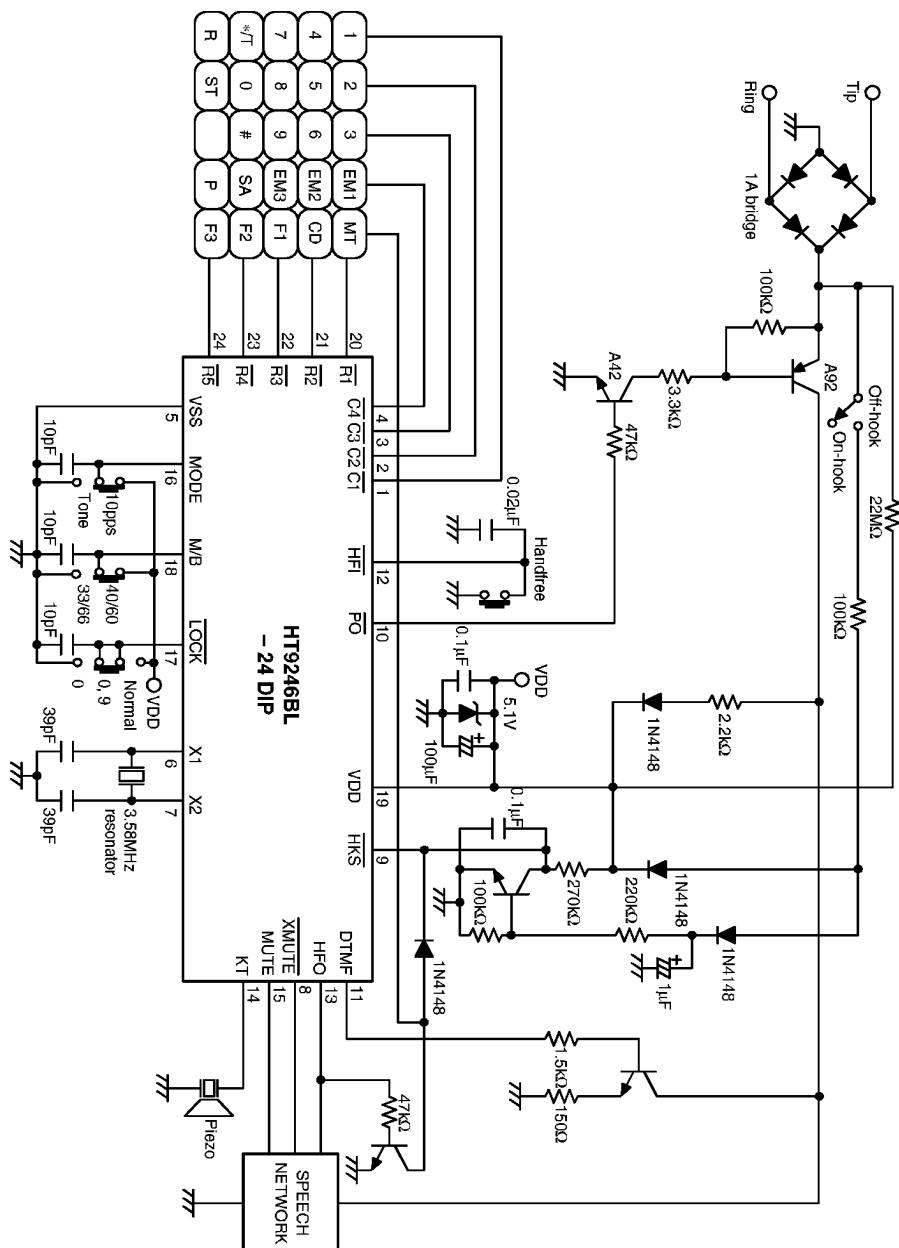
* Unspecified transistors are of 8050 type

Application circuit 2


Application circuit 3


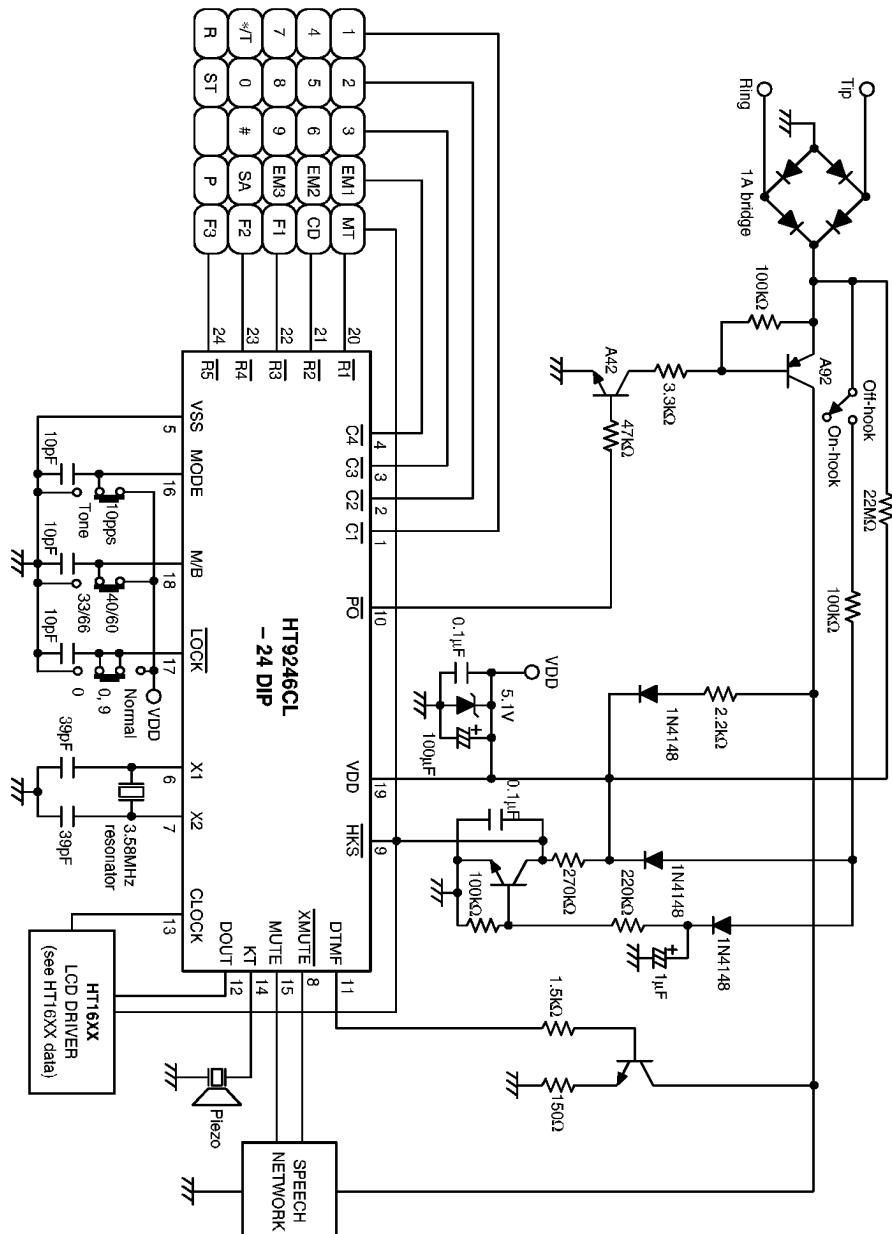
* Unspecified transistors are of 8050 type

Application circuit 4



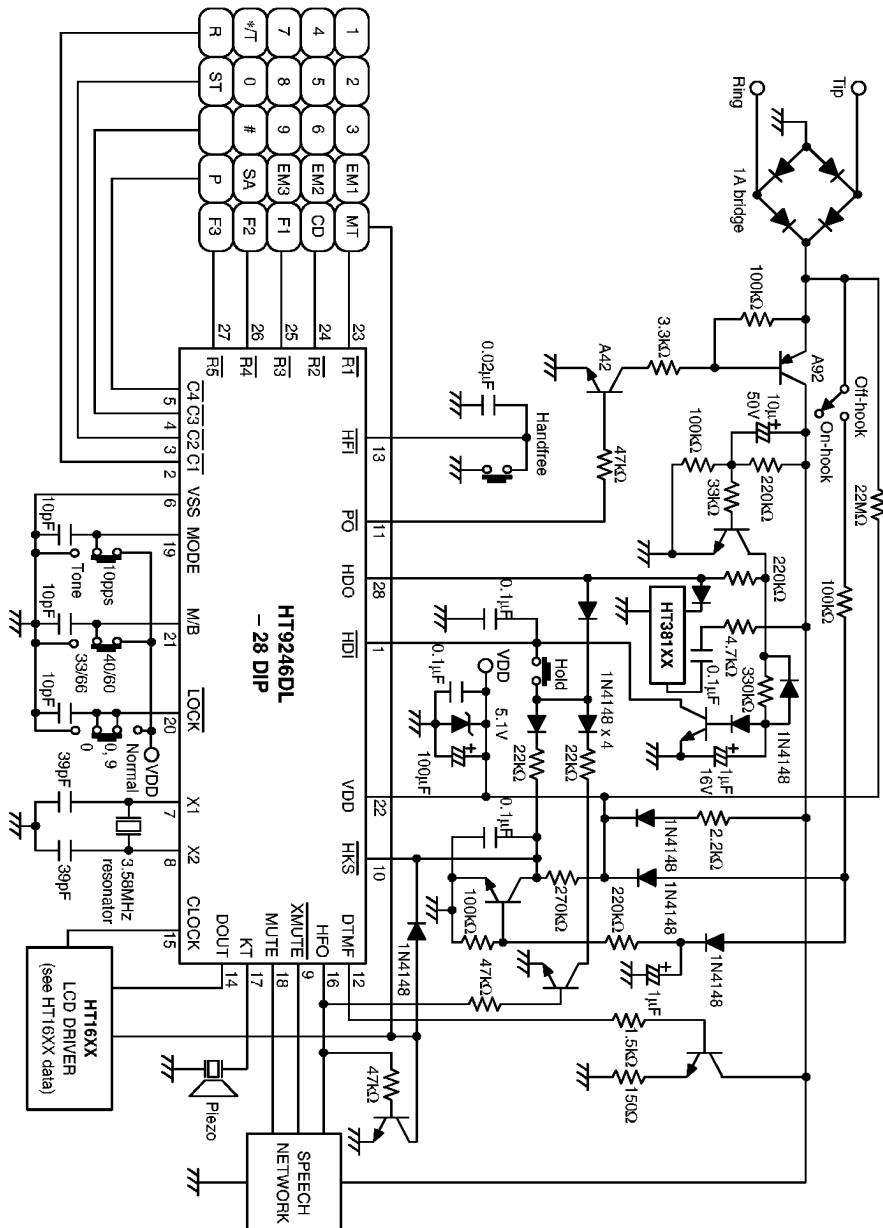
* Unspecified transistors are of 8050 type

Application circuit 5



* Unspecified transistors are of 8050 type

Application circuit 6



* Unspecified transistors are of 8050 type

* The HT381XX (HT3810 series) provides a melody during the hold period